MC7219

General Description

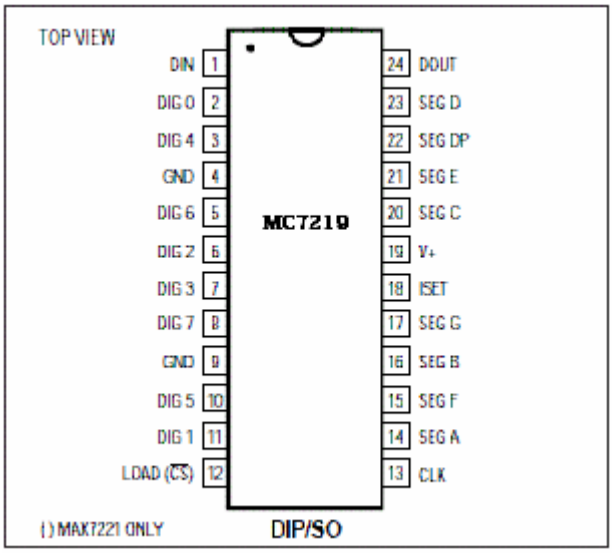
The MC7219/MAX7221 are compact, serial input/output common-cathode display drivers that interface microprocessors (µPs) to 7-segment numeric LED displays of up to 8 digits, bar-graph displays, or 64 individual LEDs. Included on-chip are a BCD code-B decoder, multiplex scan circuitry, segment and digit drivers, and an 8x8 static RAM that stores each digit. Only one external resistor is required to set the segment current for all LEDs. The MAX7221 is compatible with SPI™, QSPI™, and Microwire™, and has slew-ratelimited segment drivers to reduce EMI.

A convenient 3-wire serial interface connects to all common µPs. Individual digits may be addressed and updated without rewriting the entire display. The MC7219/MAX7221 also allow the user to select code-B decoding or no-decode for each digit.

The devices include a 150µA low-power shutdown mode, analog and digital brightness control, a scanlimit register that allows the user to display from 1 to 8 digits, and a test mode that forces all LEDs on.

Applications

Bar-Graph Displays
7-Segment Displays
Industrial Controllers
Panel Meters
LED Matrix Displays



Features

© **10MHz Serial Interface**
© **Individual LED Segment Control**
© **Decode/No-Decode Digit Selection**
© **150µA Low-Power Shutdown (Data Retained)**
© **Digital and Analog Brightness Control**
© **Display Blanked on Power-Up**
© **Drive Common-Cathode LED Display**
© **Slew-Rate Limited Segment Drivers for Lower EMI (MAX7221)**
© **SPI, QSPI, Microwire Serial Interface (MAX7221)**
© **24-Pin DIP and SO Packages**

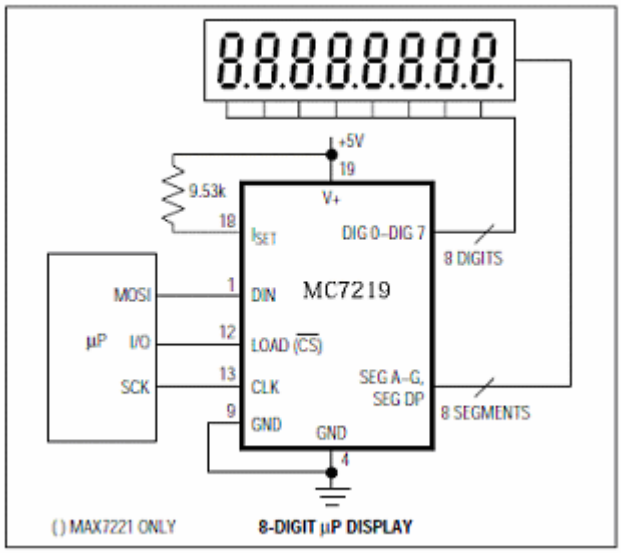
Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MC7219CNG	0°C to +70°C	24 Narrow Plastic DIP
MC7219CWG	0°C to +70°C	24 Wide SO
MC7219C/D	0°C to +70°C	Dice*
MC7219ENG	-40°C to +85°C	24 Narrow Plastic DIP
MC7219EWG	-40°C to +85°C	24 Wide SO
MC7219ERG	-40°C to +85°C	24 Narrow CERDIP

Ordering Information continued at end of data sheet.

**Dice are specified at T_A = +25°C.*

Typical Application Circuit



ABSOLUTE MAXIMUM RATINGS

Voltage (with respect to GND)

V+ .....-0.3V to 6V

DIN, CLK, LOAD, CS .....-0.3V to 6V

All Other Pins.....-0.3V to (V+ + 0.3V)

Current

DIG0–DIG7 Sink Current.....500mA

SEGA–G, DP Source Current.....100mA

Continuous Power Dissipation (T_A = +85°C)

Narrow Plastic DIP 0.87W

Wide SO 0.76W

Narrow CERDIP.....1.1W

Operating Temperature Ranges

MC7219C_G/MAX7221C_G .....0°C to +70°C

MC7219E_G/MAX7221E_G .....-40°C to +85°C

Storage Temperature Range .....-65°C to +160°C

Lead Temperature (soldering, 10sec) .....+300°C

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional

operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to

absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V+ = 5V \pm 10\%$, $R_{SET} = 9.53k\Omega \pm 1\%$, $T_A = T_{MIN}$ to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Supply Voltage	V+		4.0		5.5	V
Shutdown Supply Current	I+	All digital inputs at V+ or GND, T_A = +25°C			150	µA
Operating Supply Current	I+	R_{SET} = open circuit			8	mA
		All segments and decimal point on, $I_{SEG\_}$ = -40mA		330		
Display Scan Rate	f_{OSC}	8 digits scanned	500	800	1300	Hz
Digit Drive Sink Current	I_{DIGIT}	V+ = 5V, V_{OUT} = 0.65V	320			mA
Segment Drive Source Current	I_{SEG}	T_A = +25°C, V+ = 5V, V_{OUT} = (V+ - 1V)	-30	-40	-45	mA
Segment Current Slew Rate (MAX7221 only)	$\Delta I_{SEG}/\Delta t$	T_A = +25°C, V+ = 5V, V_{OUT} = (V+ - 1V)	10	20	50	mA/µs
Segment Drive Current Matching	ΔI_{SEG}			3.0		%
Digit Drive Leakage (MAX7221 only)	I_{DIGIT}	Digit off, V_{DIGIT} = V+			-10	µA
Segment Drive Leakage (MAX7221 only)	I_{SEG}	Segment off, V_{SEG} = 0V			1	µA
Digit Drive Source Current (MAX7219 only)	I_{DIGIT}	Digit off, V_{DIGIT} = (V+ - 0.3V)	-2			mA
Segment Drive Sink Current (MC7219 only)	I_{SEG}	Segment off, V_{SEG} = 0.3V	5			mA

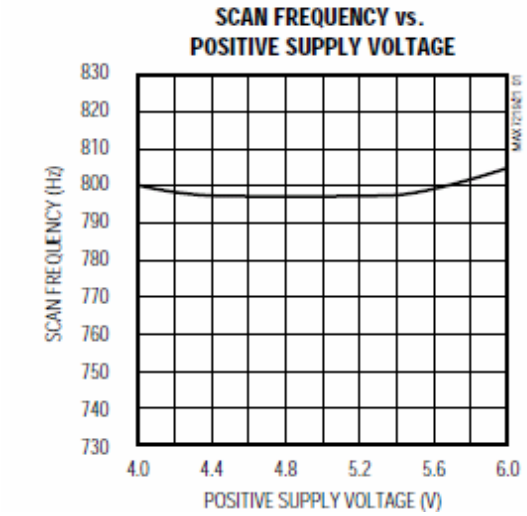
ELECTRICAL CHARACTERISTICS (continued)

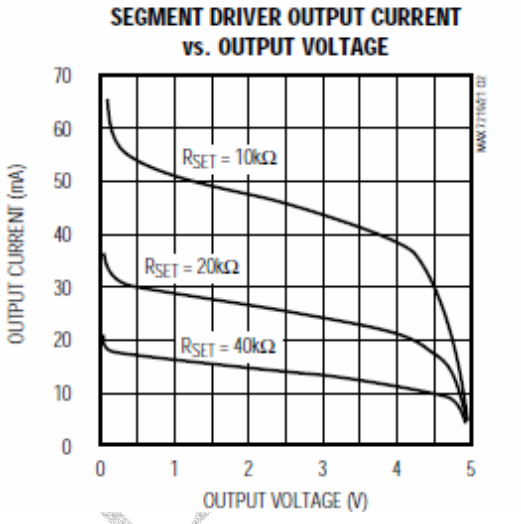
(V+ = 5V ±10%, R_{SET} =9.53kΩ ±1%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

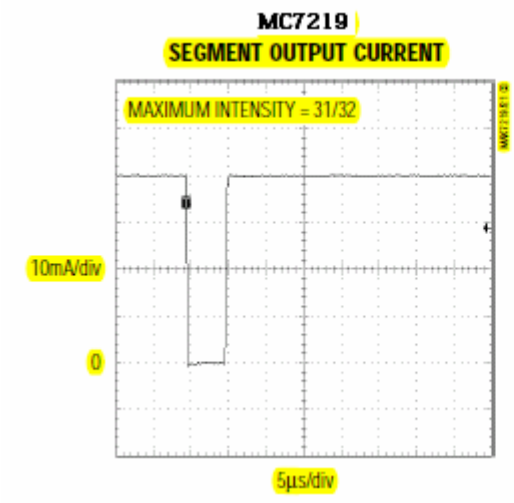
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC INPUTS						
Input Current DIN, CLK, LOAD, $\overline{CS}$	I_{IH}, I_{IL}	V_{IN} = 0V or V+	-1		1	µA
Logic High Input Voltage	V_{IH}		3.5			V
Logic Low Input Voltage	V_{IL}				0.8	V
Output High Voltage	V_{OH}	DOUT, I_{SOURCE} = -1mA	V+ - 1			V
Output Low Voltage	V_{OL}	DOUT, I_{SINK} = 1.6mA			0.4	V
Hysteresis Voltage	ΔV_I	DIN, CLK, LOAD, $\overline{CS}$		1		V
TIMING CHARACTERISTICS						
CLK Clock Period	t_{CP}		100			ns
CLK Pulse Width High	t_{CH}		50			ns
CLK Pulse Width Low	t_{CL}		50			ns
$\overline{CS}$ Fall to SCLK Rise Setup Time (MAX7221 only)	t_{CSS}		25			ns
CLK Rise to $\overline{CS}$ or LOAD Rise Hold Time	t_{CSH}		0			ns
DIN Setup Time	t_{DS}		25			ns
DIN Hold Time	t_{DH}		0			ns
Output Data Propagation Delay	t_{DO}	C_{LOAD} = 50pF			25	ns
Load-Rising Edge to Next Clock Rising Edge (MC7219 only)	t_{LDCK}		50			ns
Minimum $\overline{CS}$ or LOAD Pulse High	t_{CSW}		50			ns
Data-to-Segment Delay	t_{DSPD}				2.25	ms

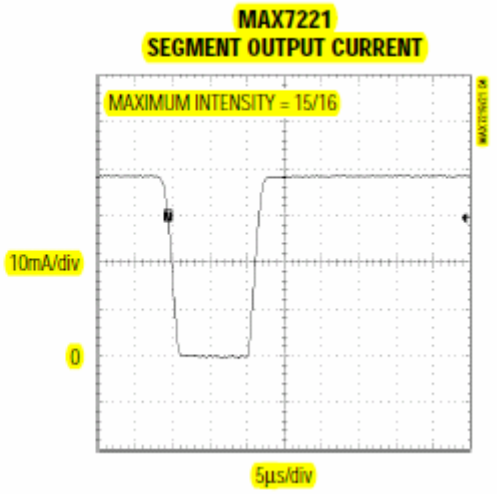
Typical Operating Characteristics

(V+ = +5V, TA = +25°C, unless otherwise noted.)





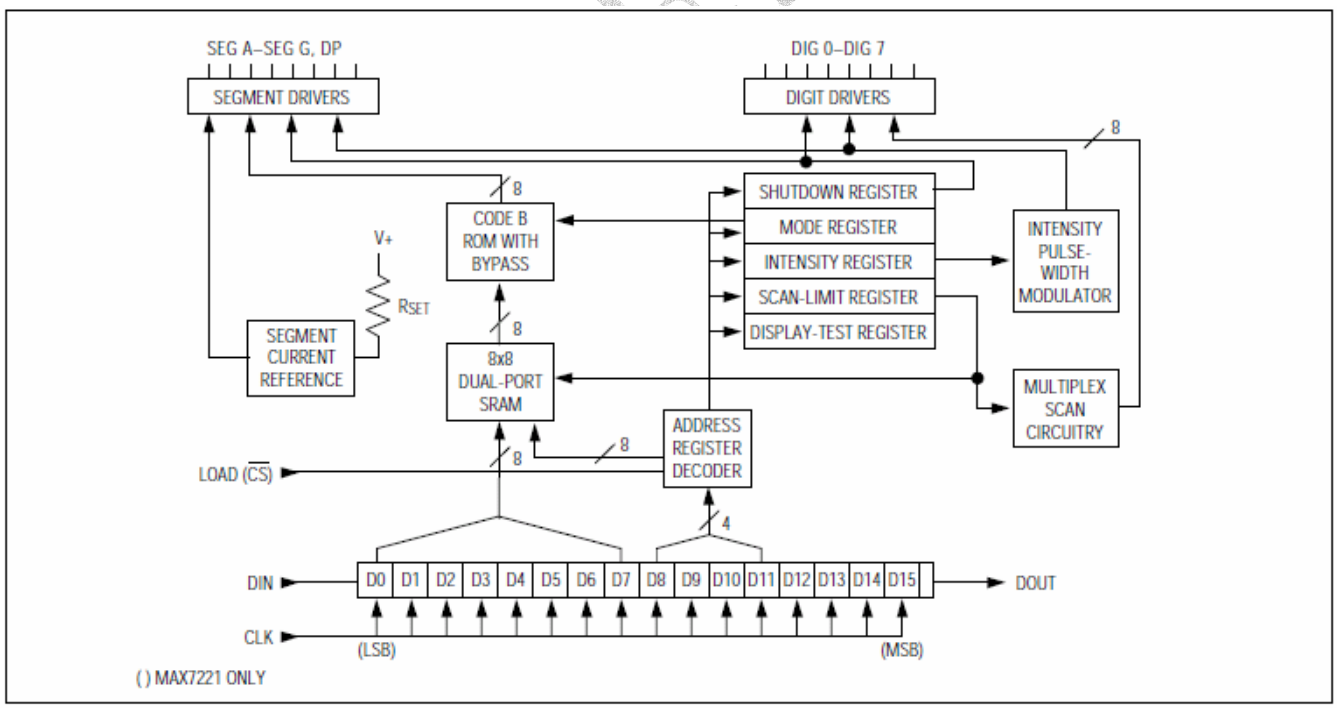




Pin Description

PIN	NAME	FUNCTION
1	DIN	Serial-Data Input. Data is loaded into the internal 16-bit shift register on CLK's rising edge.
2, 3, 5–8, 10, 11	DIG 0–DIG 7	Eight-Digit Drive Lines that sink current from the display common cathode. The MC7219 pulls the digit outputs to V+ when turned off. The MAX7221's digit drivers are high-impedance when turned off.
4, 9	GND	Ground (both GND pins must be connected)
12	LOAD (MC7219)	Load-Data Input. The last 16 bits of serial data are latched on LOAD's rising edge.
	$\overline{CS}$ (MAX7221)	Chip-Select Input. Serial data is loaded into the shift register while $\overline{CS}$ is low. The last 16 bits of serial data are latched on $\overline{CS}$'s rising edge.
13	CLK	Serial-Clock Input. 10MHz maximum rate. On CLK's rising edge, data is shifted into the internal shift register. On CLK's falling edge, data is clocked out of DOUT. On the MAX7221, the CLK input is active only while $\overline{CS}$ is low.
14–17, 20–23	SEG A–SEG G, DP	Seven Segment Drives and Decimal Point Drive that source current to the display. On the MC7219, when a segment driver is turned off it is pulled to GND. The MAX7221 segment drivers are high-impedance when turned off.
18	ISET	Connect to V_{DD} through a resistor (R_{SET}) to set the peak segment current (Refer to *Selecting R_{SET} Resistor* section).
19	V+	Positive Supply Voltage. Connect to +5V.
24	DOUT	Serial-Data Output. The data into DIN is valid at DOUT 16.5 clock cycles later. This pin is used to daisy-chain several MC7219 /MAX7221's and is never high-impedance.

Functional Diagram



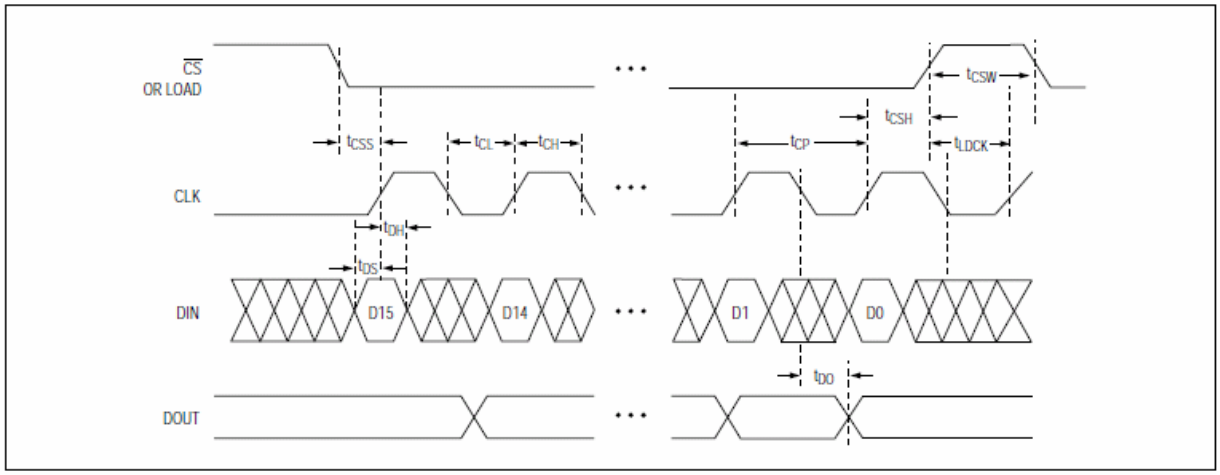


Figure 1. Timing Diagram

Table 1. Serial-Data Format (16 Bits)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
X	X	X	X	ADDRESS				MSB	DATA						LSB

Detailed Description

MC7219/MAX7221 Differences

The MC7219 and MAX7221 are identical except for two parameters: the MAX7221 segment drivers are slew-rate limited to reduce electromagnetic interference (EMI), and its serial interface is fully SPI compatible.

Serial-Addressing Modes

For the MC7219, serial data at DIN, sent in 16-bit packets, is shifted into the internal 16-bit shift register with each rising edge of CLK regardless of the state of LOAD. For the MAX7221, CS must be low to clock data in or out. The data is then latched into either the digit or control registers on the rising edge of LOAD/CS. LOAD/CS must go high concurrently with or after the 16th rising clock edge, but before the next rising clock edge or data will be lost. Data at DIN is propagated through the shift register and appears at DOUT 16.5 clock cycles later. Data is clocked out on the falling edge of CLK. Data bits are labeled D0–D15 (Table 1). D8–D11 contain the register address. D0–D7 contain the data, and D12–D15 are “don’t care” bits. The first received is D15, the most significant bit (MSB).

Digit and Control Registers

Table 2 lists the 14 addressable digit and control registers. The digit registers are realized with an on-chip, 8x8 dual-port SRAM. They are addressed directly so that individual digits can be updated and retain data as long as V+ typically exceeds 2V. The control registers consist of decode mode, display intensity, scan limit (number of scanned digits), shutdown, and display test (all LEDs on).

Shutdown Mode

When the MC7219 is in shutdown mode, the scan oscillator is halted, all segment current sources are pulled to ground, and all digit drivers are pulled to V+, thereby blanking the display. The MAX7221 is identical, except the drivers are high-impedance. Data in the digit and control registers remains unaltered. Shutdown can be used to save power or as an alarm to flash the display by successively entering and leaving shutdown mode. For minimum supply current in shutdown mode, logic inputs should be at ground or V+ (CMOS-logic levels). Typically, it takes less than 250µs for the MC7219/ MAX7221 to leave shutdown mode. The display driver can be programmed while in shutdown mode, and shutdown mode can be overridden by the display-test function.

Table 2. Register Address Map

REGISTER	ADDRESS					HEX CODE
	D15–D12	D11	D10	D9	D8	
No-Op	X	0	0	0	0	X0
Digit 0	X	0	0	0	1	X1
Digit 1	X	0	0	1	0	X2
Digit 2	X	0	0	1	1	X3
Digit 3	X	0	1	0	0	X4
Digit 4	X	0	1	0	1	X5
Digit 5	X	0	1	1	0	X6
Digit 6	X	0	1	1	1	X7
Digit 7	X	1	0	0	0	X8
Decode Mode	X	1	0	0	1	X9
Intensity	X	1	0	1	0	XA
Scan Limit	X	1	0	1	1	XB
Shutdown	X	1	1	0	0	XC
Display Test	X	1	1	1	1	XF

Initial Power-Up

On initial power-up, all control registers are reset, the display is blanked, and the MC7219/MAX7221 enter shutdown mode. Program the display driver prior to display use. Otherwise, it will initially be set to scan one digit, it will not decode data in the data registers, and the intensity register will be set to its minimum value.

Decode-Mode Register

The decode-mode register sets BCD code B (0-9, E, H, L, P, and -) or no-decode operation for each digit. Each bit in the register corresponds to one digit. A logic high selects code B decoding while logic low bypasses the decoder. Examples of the decode mode control-register format are shown in Table 4. When the code B decode mode is used, the decoder looks only at the lower nibble of the data in the digit registers (D3–D0), disregarding bits D4–D6. D7, which sets the decimal point (SEG DP), is independent of the
decoder and is positive logic (D7 = 1 turns the decimal point on). Table 5 lists the code B font.
When no-decode is selected, data bits D7–D0 correspond to the segment lines of the MC7219/MAX7221. Table 6 shows the one-to-one pairing of each data bit to the appropriate segment line.

Table 3. Shutdown Register Format (Address (Hex) = XC)

MODE	ADDRESS CODE (HEX)	REGISTER DATA							
		D7	D6	D5	D4	D3	D2	D1	D0
Shutdown Mode	XC	X	X	X	X	X	X	X	0
Normal Operation	XC	X	X	X	X	X	X	X	1

Table 4. Decode-Mode Register Examples (Address (Hex) = X9)

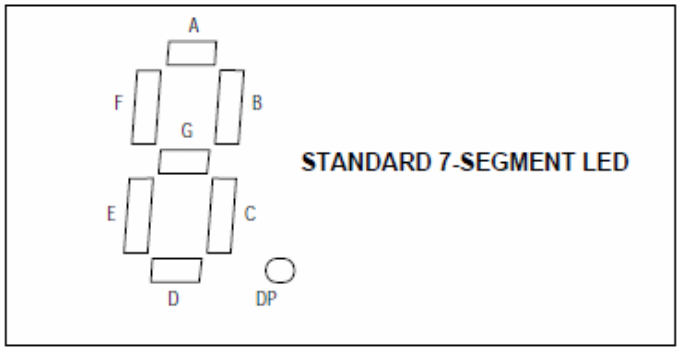
DECODE MODE	REGISTER DATA								HEX CODE
	D7	D6	D5	D4	D3	D2	D1	D0	
No decode for digits 7–0	0	0	0	0	0	0	0	0	00
Code B decode for digit 0 No decode for digits 7–1	0	0	0	0	0	0	0	1	01
Code B decode for digits 3–0 No decode for digits 7–4	0	0	0	0	1	1	1	1	0F
Code B decode for digits 7–0	1	1	1	1	1	1	1	1	FF

Table 5. Code B Font

7-SEGMENT CHARACTER	REGISTER DATA						ON SEGMENTS = 1							
	D7*	D6–D4	D3	D2	D1	D0	DP*	A	B	C	D	E	F	G
0		X	0	0	0	0		1	1	1	1	1	1	0
1		X	0	0	0	1		0	1	1	0	0	0	0
2		X	0	0	1	0		1	1	0	1	1	0	1
3		X	0	0	1	1		1	1	1	1	0	0	1
4		X	0	1	0	0		0	1	1	0	0	1	1
5		X	0	1	0	1		1	0	1	1	0	1	1
6		X	0	1	1	0		1	0	1	1	1	1	1
7		X	0	1	1	1		1	1	1	0	0	0	0
8		X	1	0	0	0		1	1	1	1	1	1	1
9		X	1	0	0	1		1	1	1	1	0	1	1
—		X	1	0	1	0		0	0	0	0	0	0	1
E		X	1	0	1	1		1	0	0	1	1	1	1
H		X	1	1	0	0		0	1	1	0	1	1	1
L		X	1	1	0	1		0	0	0	1	1	1	0
P		X	1	1	1	0		1	1	0	0	1	1	1
blank		X	1	1	1	1		0	0	0	0	0	0	0

*The decimal point is set by bit D7 = 1

Table 6. No-Decode Mode Data Bits and Corresponding Segment Lines



	REGISTER DATA							
	D7	D6	D5	D4	D3	D2	D1	D0
Corresponding Segment Line	DP	A	B	C	D	E	F	G

Intensity Control and Interdigit Blanking

The MC7219/MAX7221 allow display brightness to be controlled with an external resistor (RSET) connected between V+ and ISET. The peak current sourced from the segment drivers is nominally 100 times the current entering ISET. This resistor can either be fixed or variable to allow brightness adjustment from the front panel. Its minimum value should be 9.53Ω, which typically sets the segment current at 40mA. Display brightness

can also be controlled digitally by using the intensity register. Digital control of display brightness is provided by an internal pulse-width modulator, which is controlled by the lower nibble of the intensity register. The modulator scales the average segment current in 16 steps from a maximum of 31/32 down to 1/32 of the peak current set by RSET (15/16 to 1/16 on MAX7221). Table 7 lists the intensity register format. The minimum

interdigit blanking time is set to 1/32 of a cycle.

Table 7. Intensity Register Format (Address (Hex) = XA)

DUTY CYCLE		D7	D6	D5	D4	D3	D2	D1	D0	HEX CODE
MC7219	MAX7221									
1/32 (min on)	1/16 (min on)	X	X	X	X	0	0	0	0	X0
3/32	2/16	X	X	X	X	0	0	0	1	X1
5/32	3/16	X	X	X	X	0	0	1	0	X2
7/32	4/16	X	X	X	X	0	0	1	1	X3
9/32	5/16	X	X	X	X	0	1	0	0	X4
11/32	6/16	X	X	X	X	0	1	0	1	X5
13/32	7/16	X	X	X	X	0	1	1	0	X6
15/32	8/16	X	X	X	X	0	1	1	1	X7
17/32	9/16	X	X	X	X	1	0	0	0	X8
19/32	10/16	X	X	X	X	1	0	0	1	X9
21/32	11/16	X	X	X	X	1	0	1	0	XA
23/32	12/16	X	X	X	X	1	0	1	1	XB
25/32	13/16	X	X	X	X	1	1	0	0	XC
27/32	14/16	X	X	X	X	1	1	0	1	XD
29/32	15/16	X	X	X	X	1	1	1	0	XE
31/32	15/16 (max on)	X	X	X	X	1	1	1	1	XF

Table 8. Scan-Limit Register Format (Address (Hex) = XB)

SCAN LIMIT	REGISTER DATA								HEX CODE
	D7	D6	D5	D4	D3	D2	D1	D0	
Display digit 0 only*	X	X	X	X	X	0	0	0	X0
Display digits 0 & 1*	X	X	X	X	X	0	0	1	X1
Display digits 0 1 2*	X	X	X	X	X	0	1	0	X2
Display digits 0 1 2 3	X	X	X	X	X	0	1	1	X3
Display digits 0 1 2 3 4	X	X	X	X	X	1	0	0	X4
Display digits 0 1 2 3 4 5	X	X	X	X	X	1	0	1	X5
Display digits 0 1 2 3 4 5 6	X	X	X	X	X	1	1	0	X6
Display digits 0 1 2 3 4 5 6 7	X	X	X	X	X	1	1	1	X7

*See *Scan-Limit Register* section for application.

Scan-Limit Register

The scan-limit register sets how many digits are displayed, from 1 to 8. They are displayed in a multiplexed manner with a typical display scan rate of 800Hz with 8 digits displayed. If fewer digits are displayed, the scan rate is 8fOSC/N, where N is the number of digits scanned. Since the number of scanned digits affects the display brightness, the scan-limit register should not be used to blank portions of the display (such as leading zero suppression). Table 8 lists the scan-limit register format.

If the scan-limit register is set for three digits or less, individual digit drivers will dissipate excessive amounts of power. Consequently, the value of the RSET resistor must be adjusted according to the number of digits displayed, to limit individual digit driver power dissipation. Table 9 lists the number of digits displayed and the corresponding maximum recommended segment current when the digit drivers are used.

Display-Test Register

The display-test register operates in two modes: normal and display test. Display-test mode turns all LEDs on by overriding, but not altering, all controls and digit registers (including the shutdown register). In display-test mode, 8 digits are scanned and the duty cycle is 31/32 (15/16 for MAX7221). Table 10 lists the display-test reg ister format.

Table 9. Maximum Segment Current for 1-, 2-, or 3-Digit Displays

NUMBER OF DIGITS DISPLAYED	MAXIMUM SEGMENT CURRENT (mA)
1	10
2	20
3	30

Table 10. Display-Test Register Format (Address (Hex) = XF)

MODE	REGISTER DATA							
	D7	D6	D5	D4	D3	D2	D1	D0
Normal Operation	X	X	X	X	X	X	X	0
Display Test Mode	X	X	X	X	X	X	X	1

Note: The MC7219/MAX7221 remain in display-test mode (all LEDs on) until the display-test register is reconfigured for normal operation

No-Op Register

The no-op register is used when cascading MC7219s or MAX7221s. Connect all devices' LOAD/CS inputs together and connect DOUT to DIN on adjacent devices. DOUT is a CMOS logic-level output that easily drives DIN of successively cascaded parts. (Refer to the Serial Addressing Modes section for detailed information on serial input/output timing.) For example, if four MC7219s are cascaded, then to write to the fourth chip, sent the desired 16-bit word, followed by three no-op codes (hex XX0X, see Table 2). When LOAD/CS goes high, data is latched in all devices. The first three chips receive no-op commands, and the fourth receives the intended data.

Applications Information Supply Bypassing and Wiring

To minimize power-supply ripple due to the peak digit driver currents, connect a 10µF electrolytic and a 0.1µF ceramic capacitor between V+ and GND as close tothe device as possible. The MC7219/MAX7221 should be placed in close proximity to the LED display, and connections should be kept as short as possible to minimize the effects of wiring inductance and electromagnetic interference. Also, both GND pins must be connected to ground.

Selecting RSET Resistor and Using External Drivers

The current per segment is approximately 100 times the current in ISET. To select RSET, see Table 11. The MC7219/MAX7221's maximum recommended segment current is 40mA. For segment current levels above these levels, external digit drivers will be needed. In this application, the MC7219/MAX7221 serve only as controllers for other high-current drivers or transistors. Therefore, to conserve power, use RSET = 47k when using external current sources as segment drivers.

The example in Figure 2 uses the MC7219/MAX7221's segment drivers, a MAX394 single-pole double-throw analog switch, and external transistors to drive 2.3" AND2307SLC common-cathode displays. The 5.6V zener diode has been added in series with the decimal point LED because the decimal point LED forward voltage is typically 4.2V. For all other segments the LED forward voltage is typically 8V. Since external transistors are used to sink current (DIG 0 and DIG 1 are used as logic switches), peak segment currents of 45mA are allowed even though only two digits are displayed. In applications where the MC7219/MAX7221's digit drivers are used to sink current and fewer than four digits are displayed, Table 9 specifies the maximum allowable segment current. RSET must be selected accordingly (Table 11). Refer to the Power Dissipation section of the Absolute Maximum Ratings to calculate acceptable limits for ambient temperature, segment

current, and the LED forward-voltage drop.

Table 11. RSET vs. Segment Current and LED Forward Voltage

I_{SEG} (mA)	V_{LED} (V)				
	1.5	2.0	2.5	3.0	3.5
40	12.2	11.8	11.0	10.6	9.69
30	17.8	17.1	15.8	15.0	14.0
20	29.8	28.0	25.9	24.5	22.6
10	66.7	63.7	59.3	55.4	51.2

Computing Power Dissipation

The upper limit for power dissipation (PD) for the MC7219/MAX7221 is determined from the following equation: PD = (V + x 8mA) + (V+ - V_{LED})(DUTY x I_{SEG} x N)

where: V+ = supply voltage DUTY = duty cycle set by intensity register N = number of segments driven (worst case is 8) V_{LED} = LED forward voltage I_{SEG} = segment current set by RSET

Dissipation Example:

I_{SEG} = 40mA, N = 8, DUTY = 31/32, V_{LED} = 1.8V at 40mA, V+ = 5.25V

PD = 5.25V(8mA) + (5.25V - 1.8V)(31/32 x 40mA x 8) = 1.11W

Thus, for a CERDIP package (θ_{JA} = +60°C/W from Table 12), the maximum allowed ambient temperature T_A is given by:

$T_{J(MAX)} = T_A + PD \times \theta_{JA} + 150°C = T_A + 1.11W \times 60°C/W$

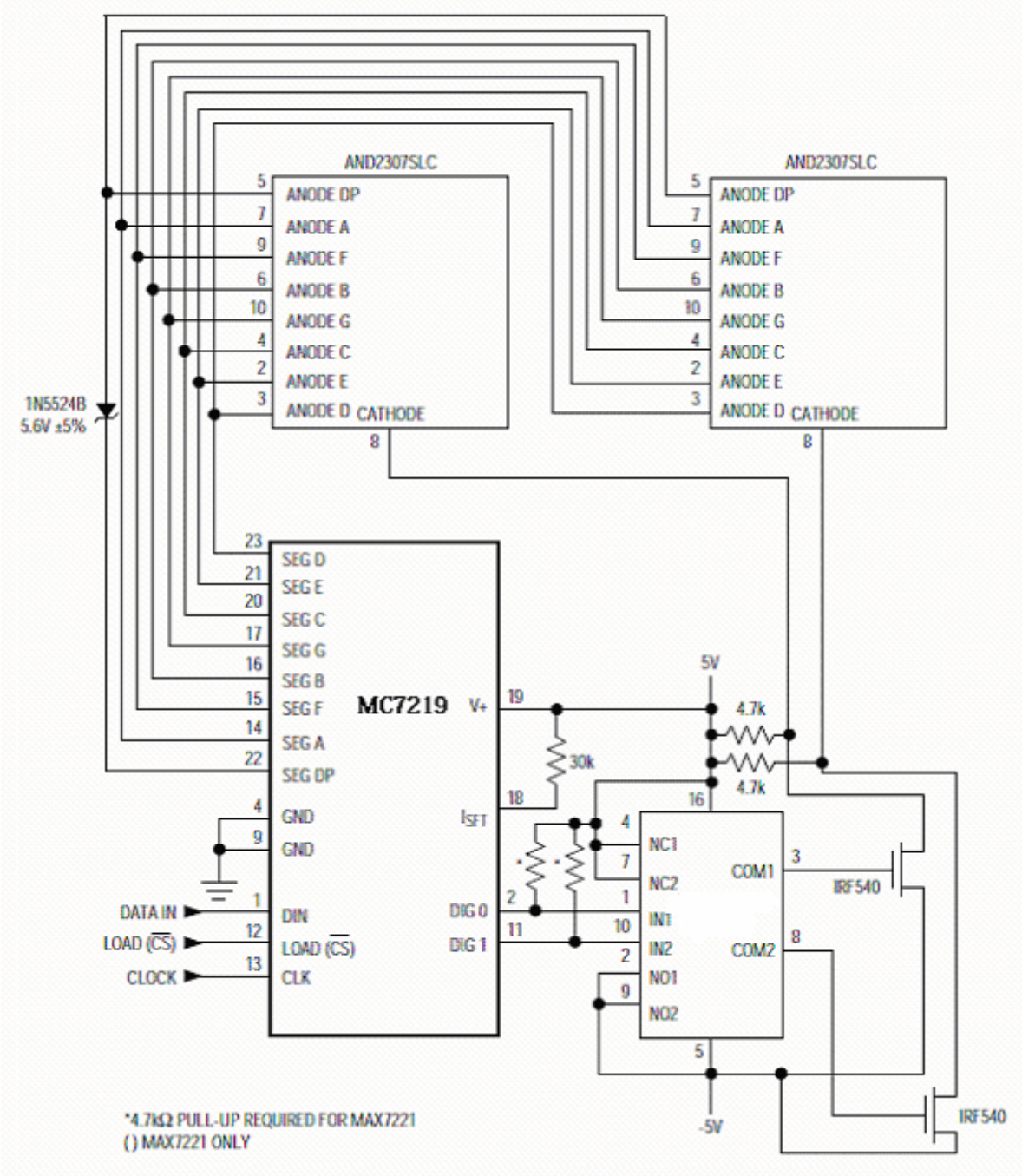
where T_A = +83.4°C.

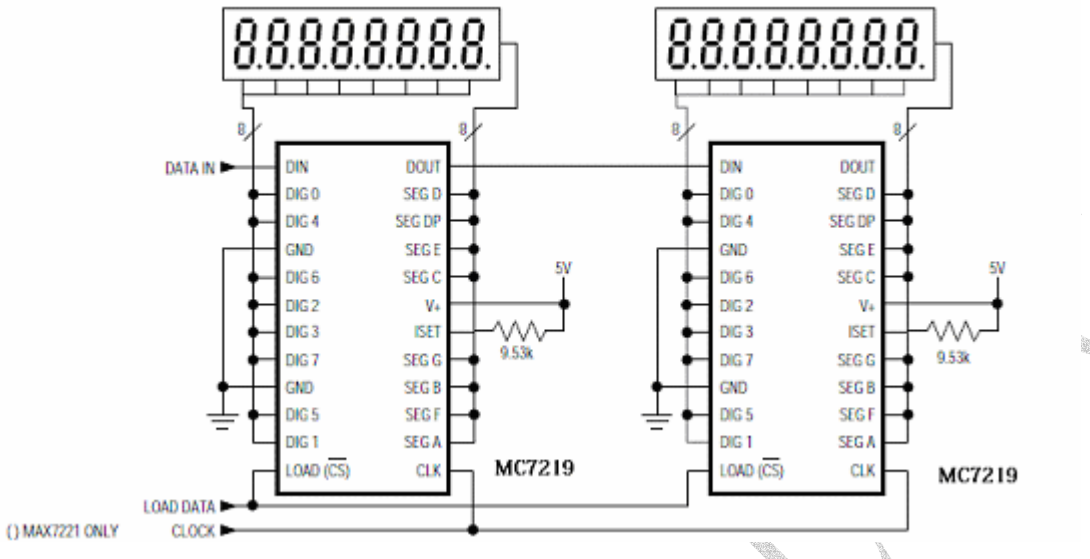
Table 12. Package Thermal Resistance Data

PACKAGE	THERMAL RESISTANCE (θ_{JA})
24 Narrow DIP	+75°C/W
24 Wide SO	+85°C/W
24 CERDIP	+60°C/W
Maximum Junction Temperature (T_J) = +150°C	
Maximum Ambient Temperature (T_A) = +85°C	

Cascading Drivers

The example in Figure 3 drives 16 digits using a 3-wire µP interface. If the number of digits is not a multiple of 8, set both drivers' scan limits registers to the same number so one display will not appear brighter than the other. For example, if 12 digits are need, use 6 digits per display with both scan-limit registers set for 6 digits so that both displays have a 1/6 duty cycle per digit. If 11 digits are needed, set both scan-limit registers for 6 digits and leave one digit driver unconnected. If one display for 6 digits and the other for 5 digits, the second display will appear brighter because its duty cycle per digit will be 1/5 while the first display's will be 1/6. Refer to the No-Op Register section for additional information.


AND2307SLC
ANODE DP
ANODE A
ANODE F
ANODE B
ANODE G
ANODE C
ANODE E
ANODE D
CATHODE
1N5524B
5.6V ±5%
MC7219
SEG D
SEG E
SEG C
SEG G
SEG B
SEG F
SEG A
SEG DP
GND
GND
DIN
LOAD (CS)
CLK
V+
ISET
DIG 0
DIG 1
DATA IN
LOAD (CS)
CLOCK
5V
4.7k
4.7k
30k
NC1
NC2
IN1
IN2
NO1
NO2
COM1
COM2
IRF540
IRF540
-5V
*4.7kΩ PULL-UP REQUIRED FOR MAX7221
( ) MAX7221 ONLY

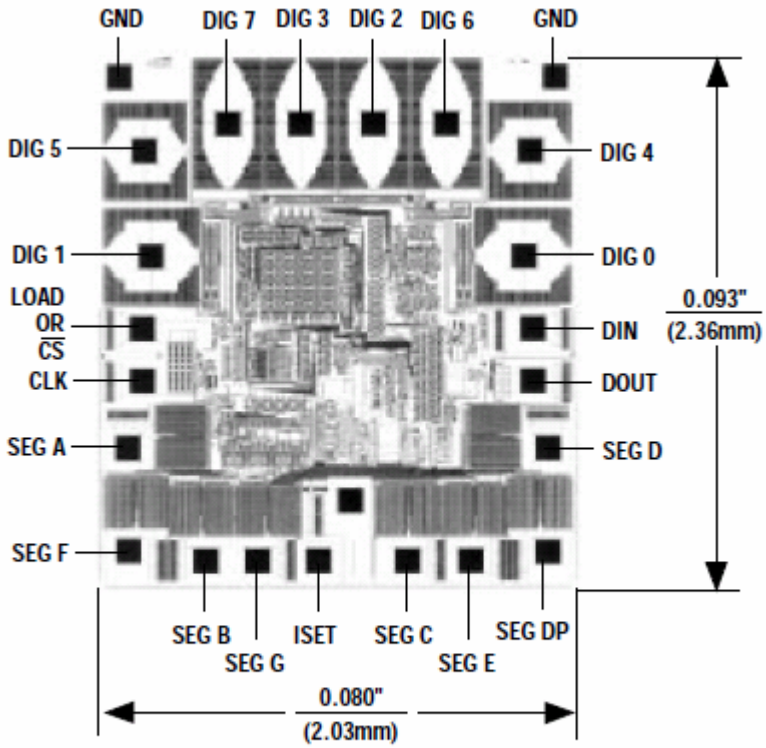

DATA IN
LOAD DATA
CLOCK
() MAX7221 ONLY
DIN
DIG 0
DIG 4
GND
DIG 6
DIG 2
DIG 3
DIG 7
GND
DIG 5
DIG 1
LOAD (CS)
DOUT
SEG D
SEG DP
SEG E
SEG C
V+
ISET
SEG G
SEG B
SEG F
SEG A
CLK
5V
9.53k
MC7219
MC7219

_Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE
MAX7221CNG	0°C to +70°C	24 Narrow Plastic DIP
MAX7221CWG	0°C to +70°C	24 Wide SO
MAX7221C/D	0°C to +70°C	Dice*
MAX7221ENG	-40°C to +85°C	24 Narrow Plastic DIP
MAX7221EWG	-40°C to +85°C	24 Wide SO
MAX7221ERG	-40°C to +85°C	24 Narrow CERDIP

*Dice are specified at T_A = +25°C.

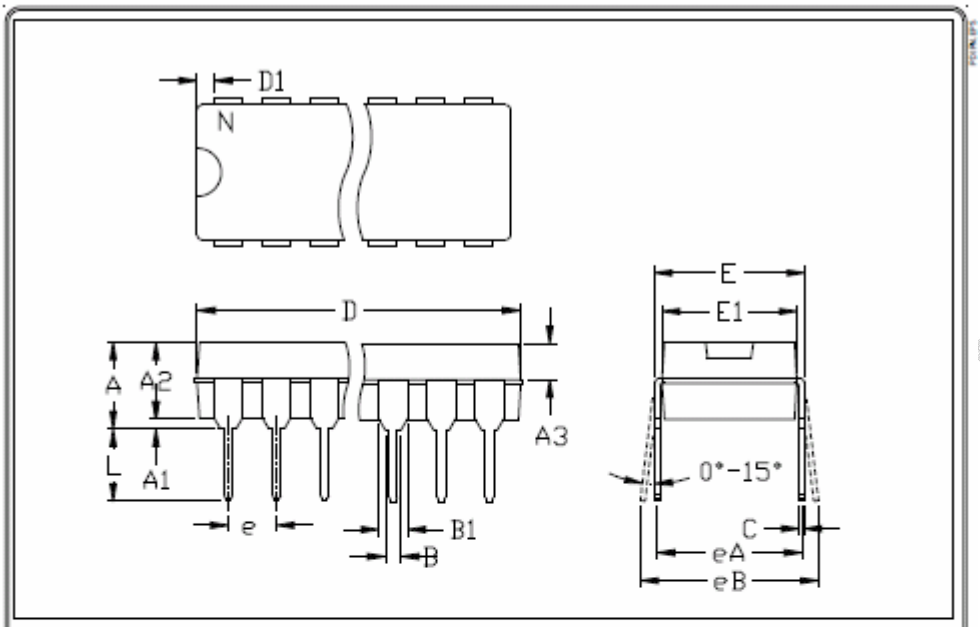
Chip Topography



TRANSISTOR COUNT: 5267

SUBSTRATE CONNECTED TO GND

Package Information

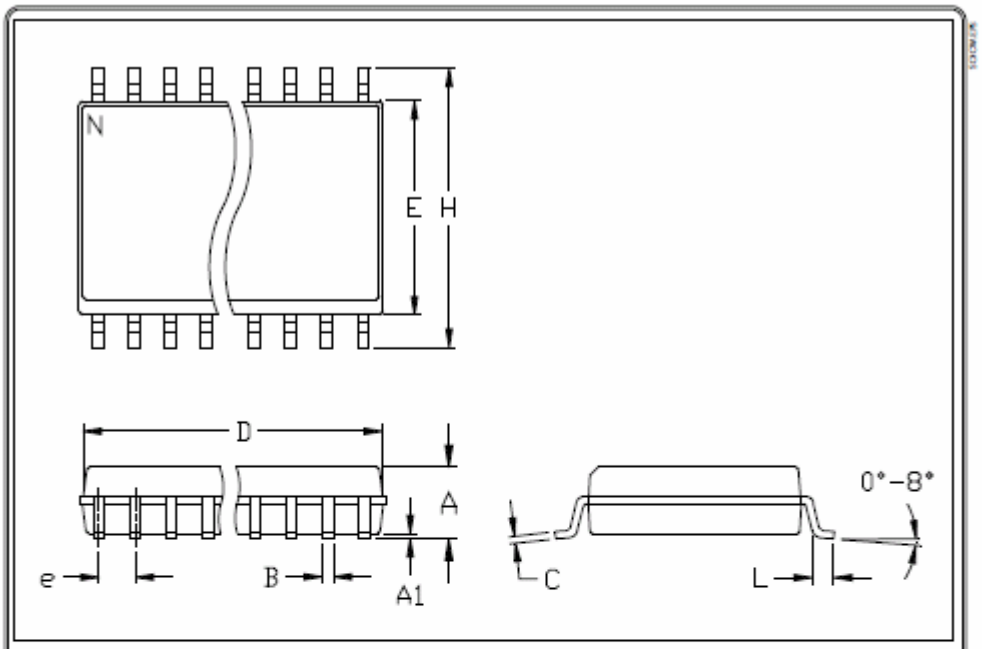


	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.200	---	5.08
A1	0.015	---	0.38	---
A2	0.125	0.175	3.18	4.45
A3	0.055	0.080	1.40	2.03
B	0.016	0.022	0.41	0.56
B1	0.045	0.065	1.14	1.65
C	0.008	0.012	0.20	0.30
D1	0.005	0.080	0.13	2.03
E	0.300	0.325	7.62	8.26
E1	0.240	0.310	6.10	7.87
e	0.100	---	2.54	---
eA	0.300	---	7.62	---
eB	---	0.400	---	10.16
L	0.115	0.150	2.92	3.81

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS001
D	0.348	0.390	8.84	9.91	8	AB
D	0.735	0.765	18.67	19.43	14	AC
D	0.745	0.765	18.92	19.43	16	AA
D	0.885	0.915	22.48	23.24	18	AD
D	1.015	1.045	25.78	26.54	20	AE
D	1.14	1.265	28.96	32.13	24	AF
D	1.360	1.380	34.54	35.05	28	*5

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC MS001-XX AS SHOWN IN ABOVE TABLE
5. SIMILIAR TO JEDEC MO-058AB
6. N = NUMBER OF PINS

Package Information (continued)



	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.093	0.104	2.35	2.65
A1	0.004	0.012	0.10	0.30
B	0.014	0.019	0.35	0.49
C	0.009	0.013	0.23	0.32
e	0.050		1.27	
E	0.291	0.299	7.40	7.60
H	0.394	0.419	10.00	10.65
h	0.010	0.030	0.25	0.75
L	0.016	0.050	0.40	1.27

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS013
D	0.398	0.413	10.10	10.50	16	AA
D	0.447	0.463	11.35	11.75	18	AB
D	0.496	0.512	12.60	13.00	20	AC
D	0.598	0.614	15.20	15.60	24	AD
D	0.697	0.713	17.70	18.10	28	AE

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. LEADS TO BE COPLANAR WITHIN .102mm (.004")
4. CONTROLLING DIMENSION: MILLIMETER
5. MEETS JEDEC MS013-XX AS SHOWN IN ABOVE TABLE
6. N = NUMBER OF PINS